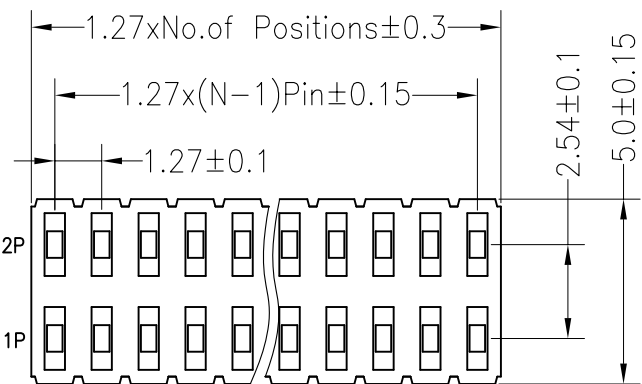
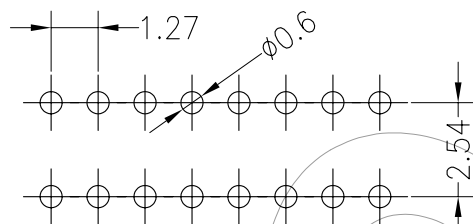


RoHS



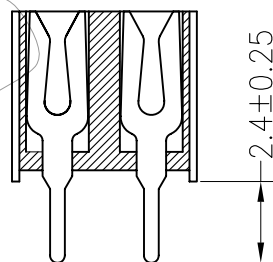
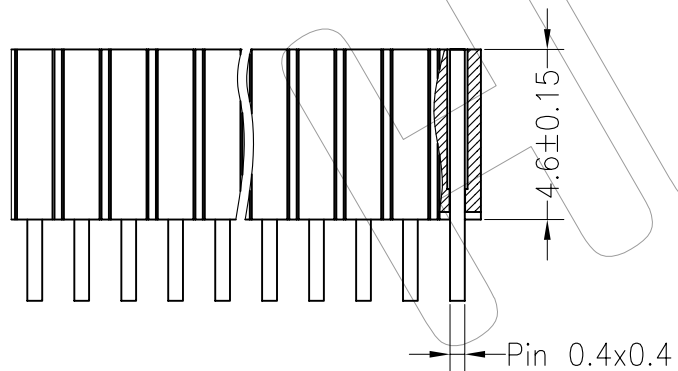
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Ordering Information

HC-FH646 02 XX X N XX S Y X 01

No.of
Pins
Per Row
2*50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
O=PE Bag
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

Φ

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH64602XXXNXXSYX01

TITLE:

1.27x2.54mm H4.6 Dual Row Straight
Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9